## Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-O20D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Marking Information: See page 2
- Ordering Information: See Page 2
- Weight: 0.008 grams (approximate)


TOP VIEW


TOP VIEW Internal Schematic

Maximum Ratings $@ T_{A}=25^{\circ} \mathrm{C}$ unless otherwise specified

| Characteristic |  | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage |  | $V_{\text {RRM }}$ <br> $V_{\text {RWM }}$ $V_{R}$ | 85 | V |
| RMS Reverse Voltage |  | $\mathrm{V}_{\mathrm{R} \text { (RMS) }}$ | 60 | V |
| Forward Continuous Current (Note 1) | Single Diode Double Diode | Ifm | $\begin{aligned} & 215 \\ & 125 \end{aligned}$ | mA |
| Repetitive Peak Forward Current |  | IfRM | 500 | mA |
| Non-Repetitive Peak Forward Surge Current | $@ \mathrm{t}=1.0 \mu \mathrm{~s}$ <br> @ $\mathrm{t}=1.0 \mathrm{~ms}$ <br> @ $\mathrm{t}=1.0 \mathrm{~s}$ | IfSM | $\begin{aligned} & \hline 4.0 \\ & 1.0 \\ & 0.5 \end{aligned}$ | A |

## Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Power Dissipation (Note 1) | $\mathrm{P}_{\mathrm{D}}$ | 250 | mW |
| Thermal Resistance Junction to Ambient Air (Note 1) | $\mathrm{R}_{\theta J \mathrm{~A}}$ | 500 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Operating and Storage Temperature Range | $\mathrm{T}_{\mathrm{J},}, \mathrm{T}_{\text {STG }}$ | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |

Electrical Characteristics $@ \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise specified

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Reverse Breakdown Voltage (Note 2) | $\mathrm{V}_{(\mathrm{BR}) \mathrm{R}}$ | 85 | - | - | V | $\mathrm{I}_{\mathrm{R}}=100 \mu \mathrm{~A}$ |
| Forward Voltage | $V_{\text {F }}$ | - | - | $\begin{gathered} 0.90 \\ 1.0 \\ 1.1 \\ 1.25 \end{gathered}$ | V | $\begin{aligned} & \mathrm{I}_{\mathrm{F}}=1.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{F}}=10 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{F}}=50 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{F}}=150 \mathrm{~mA} \end{aligned}$ |
| Leakage Current (Note 2) | IR | - | - | $\begin{aligned} & 5.0 \\ & 80 \\ & \hline \end{aligned}$ | $\begin{aligned} & \hline \mathrm{nA} \\ & \mathrm{nA} \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{R}}=75 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{R}}=75 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=150^{\circ} \mathrm{C} \end{aligned}$ |
| Total Capacitance | $\mathrm{C}_{\text {T }}$ | - | 2 | - | pF | $\mathrm{V}_{\mathrm{R}}=0, \mathrm{f}=1.0 \mathrm{MHz}$ |
| Reverse Recovery Time | $\mathrm{trr}_{\text {r }}$ | - | - | 3.0 | $\mu \mathrm{S}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{F}}=\mathrm{I}_{\mathrm{R}}=10 \mathrm{~mA}, \\ & \mathrm{I}_{\mathrm{rr}}=0.1 \times \mathrm{I}_{\mathrm{R}}, \mathrm{R}_{\mathrm{L}}=100 \Omega \end{aligned}$ |

Notes: 1. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
. Short duration pulse test used to minimize self-heating effect.
. No purposefully added lead. Halogen and Antimony Free.
4. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or $\mathrm{Sb}_{2} \mathrm{O}_{3}$ Fire Retardants.

BAV170


Fig. 1 Power Derating Curve


Fig. 3 Typical Reverse Characteristics


Fig. 2 Typical Forward Characteristics


Fig. 4 Current Derating Curve

Ordering Information (Note 5)

| Part Number |  |  |  | Case |  |  |  |  | Packaging |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| BAV170-7-F |  |  |  | SOT-23 |  |  |  | 3000/Tape \& Reel |  |  |  |  |
| Notes: $\quad$ 5. For packaging details, go to our website at http://mww.diodes.com/datasheets/ap02007.pdf. |  |  |  |  |  |  |  |  |  |  |  |  |
| Marking Information |  |  |  |  |  |  |  |  |  |  |  |  |
| K51 = Product Type Marking Code YM = Date Code Marking Y = Year ex: N = 2002 <br> M = Month ex: 9 = September |  |  |  |  |  |  |  |  |  |  |  |  |
| Year | 2001 | 2002 | 2003 | 2004 | 2005 | 2006 | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 |
| Code | M | N | P | R | S | T | U | V | W | X | Y | Z |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |

## Package Outline Dimensions



| SOT-23 |  |  |
| :---: | :---: | :---: |
| Dim | Min | Max |
| A | 0.37 | 0.51 |
| B | 1.20 | 1.40 |
| C | 2.30 | 2.50 |
| D | 0.89 | 1.03 |
| F | 0.45 | 0.60 |
| G | 1.78 | 2.05 |
| H | 2.80 | 3.00 |
| J | 0.013 | 0.10 |
| K | 0.903 | 1.10 |
| L | 0.45 | 0.61 |
| M | 0.085 | 0.180 |
| $\mathbf{\alpha}$ | $0^{\circ}$ | $8^{\circ}$ |
| All Dimensions in $\mathbf{~ m m}$ |  |  |

## Suggested Pad Layout



| Dimensions | Value (in mm) |
| :---: | :---: |
| $\mathbf{Z}$ | 2.9 |
| $\mathbf{X}$ | 0.8 |
| $\mathbf{Y}$ | 0.9 |
| $\mathbf{C}$ | 2.0 |
| $\mathbf{E}$ | 1.35 |

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